ASSOCIATION CONNECTING ELECTRONICS INDUSTRIESS International and Pa	IPC. Bannockl	ourn, Illinois, A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declarati he declaration e	on of the su	ibstances v s all lower	within the manufactu level materials for v	urer listed which the	item. Note: manufactur	: if the item is an as er has engineering	sembly with low responsibility.	
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials a				rials and N	Afg Inform	ation			
upplier Information														
Company name* Com			Company unique ID			Unique ID Authority				Respon	Response Date*			
onsemi										2024-0	2024-05-15			
Contact Name Title - Contact			act			Phone - Contact*				Email	Email - Contact*			
Product-Env-Stewards Product En			ct Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Repr			epresentative			Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards Product Envi			Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date Version Manufacturing State		Ianufacturing Site		Weight*	UOM	Unit Type		
	NCV306	NCV3065MNTXG 1.5A SW		A SW REG FOR LED NCV		2024-05-15		M	MY1		40.0	mg	Each	
Ianufacturing Proccess Informa	ation						-							
Terminal Plating / Grid Array M	Iaterial 7	Ferminal Base A	lloy J-STD-020 MSL Rati		L Rating	Peak Proc	Process Body Temperature		re Max Time at Peak Tempera		ature Nun	nber of Reflow Cyc	eles	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		<b>260</b> C		C	30 seco		seconds 3			
omments														
vel 1 - maximum time at peak temperat	ture during so	ldering is 10-3	0 seconds											
or more information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.4	mg	Supplier	Silicon (Si)	7440-21-3		0.4	mg
Die Attach	0.95	mg	Supplier	Silver (Ag)	7440-22-4		0.7125	mg
			Supplier	Epoxy resins	129915-35-1		0.2375	mg
Lead Frame	14.94	mg	Supplier	Silver (Ag)	7440-22-4		2.9282	mg
			Supplier	Iron (Fe)	7439-89-6		0.1195	mg
			Supplier	Copper (Cu)	7440-50-8		11.8922	mg
Mold Compound-Black	20.0	mg		Epoxy resin	proprietary data		1.4	mg
				Phenolic Resin	Proprietary Data		1.4	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		3	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		14.1	mg
Plating	1.11	mg	Supplier	Tin (Sn)	7440-31-5		1.11	mg
Wire Bond - Au	2.6	mg	Supplier	Gold (Au)	7440-57-5		2.6	mg